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## SSTUB32866CHLF

Category:	
Generic Part:	SSTUB32866C
Market Group:	RDIMM
Description:	1.8V REG. BUFFER (800 MHZ)



### Parameters

Package	CABGA 96 (BFG96)
Speed	NA
Temperature	C
Voltage	3.3 V
Status	Active
Sample	No
Minimum Order Quantity	270
Factory Order Increment	270

### Distributor Inventory

No Pricing information is available from our Distributors at this time.

### Documents

Type	Title	Size	Revision Date
Product Change Notice	PCN# : A-0607-02 IDT Penang as Alternate Assembly Facility for ICS CVBGA and FPBGA	100 KB	07/27/2006
	PCN# A-0607-05 Green Mold Compound KMC3580 for BGA	195 KB	08/30/2006
	PCN# : A-0610-02 ASAT China as Alternate Facility for CABGA/CV BGA/FPBGA/TQFP/PQFP	253 KB	10/19/2006

### Package

Description	CHIP ARRAY BGA 5.5 X 13.5 MM X 0.8 MM PI
Class	PLASTIC
Moisture Sensitivity Level (MSL)	3
Category	Green
Moisture Exposure Floor Life	168 hrs. @ <30°C/60%RH
Peak Reflow Temperature	260°C
Rebake Conditions	48 hrs.@125°C
Length	13.5
Mark	H
Width	5.5
Pitch	0.8
Thickness	1.4
Status	Active